506350595 11/12/2020

EPAS ID: PAT6397350

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

SUBMISSION TYPE:

CORRECTIVE ASSIGNMENT

Corrective Assignment to correct the TYPOGRAPHICAL ERROR IN NAME FOR INVENTOR #3 previously recorded on Reel 048077 Frame 0129. Assignor(s) hereby confirms the ASSIGNMENT OF ASSIGNORS INTEREST.

CONVEYING PARTY DATA

Name	Execution Date
CHIH-CHANG HUNG	01/08/2019
CHIEH-NING FENG	01/08/2019
CHUN-LIANG LAI	01/08/2019
YIH-ANN LIN	01/08/2019
RYAN CHIA-JEN CHEN	01/09/2019

RECEIVING PARTY DATA

Name:	Taiwan Semiconductor Manufacturing Co., Ltd.		
Street Address:	8, Li-Hsin Rd. 6, Hsinchu Science Park		
City:	Hsinchu		
State/Country:	TAIWAN		
Postal Code:	300-78		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16248242

CORRESPONDENCE DATA

Fax Number: (972)732-9218

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 972-732-1001

Email: docketing@slatermatsil.com

Correspondent Name: SLATER MATSIL, LLP

Address Line 1: 17950 PRESTON RD., SUITE 1000

Address Line 4: DALLAS, TEXAS 75252

ATTORNEY DOCKET NUMBER:	TSMP20182329US00
NAME OF SUBMITTER:	CANDICE CASTRO
SIGNATURE:	/Candice Castro/
DATE SIGNED:	11/12/2020

PATENT 506350595 REEL: 054393 FRAME: 0646

Total Attachments: 2

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PATENT REEL: 054393 FRAME: 0647

ATTORNEY DOCKET NO. TSMP20182329US00

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd. ("Assignee"), a corporation organized and existing under the laws of Taiwan, with its principal office at 8, Li-Hsin Rd. 6 Hsinchu Science Park, Hsinchu 300-78 Taiwan, is desirous of acquiring my entire right, title and interest in and to said invention, and to said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to said Assignee, its successors and assigns, my entire right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all future non-provisional applications including divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to said Assignee, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to Assignee, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said Assignee, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said Assignee, its legal representatives, successors, or assigns, will testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said Assignee, its legal representatives, successors, and assigns, to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year:

TITLE OF INVENTION	CUT METAL GATE SHAPE WITH FIRE BAR PROFILE TO CLEAN SIDEWALL METAL RESIDUE		
SIGNATURE OF INVENTOR AND NAME	Jrh-an, Ki	Ryan Chia-Jen Chen	
DATE	1/8/2019	Of 09/2019	
RESIDENCE	Jhudong Township, Taiwan	Chiayi, Talwan	

ATTORNEY DOCKET NO. TSMP20182329US00

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd. ("Assignee"), a corporation organized and existing under the laws of Taiwan, with its principal office at 8, Li-Hsin Rd. 6 Hsinchu Science Park, Hsinchu 300-78 Taiwan, is desirous of acquiring my entire right, title and interest in and to said invention, and to said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to said Assignee, its successors and assigns, my entire right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all future non-provisional applications including divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to said Assignee, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to Assignee, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said Assignee, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said Assignee, its legal representatives, successors, or assigns, will testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful caths, and generally do everything possible to aid said Assignee, its legal representatives, successors, and assigns, to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	CUT METAL GATE SHAPE WITH FIRE BAR PROFILE TO CLEAN SIDEWALL METAL RESIDUE		
SIGNATURE OF INVENTOR AND NAME	Ohih-Chrony Hung Chih-Chang Hung	Chieh-Ning Feng 报诉算 Chieh-Ning Feng	Chuly Ly Chun-Liang Lai
DATE	2019/1/8	2019/1/8	01-08-2019
RESIDENCE	Hsinchu, Taiwan	Hsinchu, Taiwan	Hsinchu, Taiwan

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Assignment

PATENT REEL: 054393 FRAME: 0649